



80V +175°C N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BV _{DSS}	Rds(on) Max	I _D Tc = +25°C
80V	$3.9 \text{m}\Omega$ @ $V_{GS} = 10V$	120A
	6mΩ @ V _{GS} = 6V	97A

Description and Applications

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Switching
- Synchronous Rectification
- DC-DC Converters

Features

- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching Test in Production Ensures More Reliable and Robust End Application
- Thermally Efficient Package Cooler Running Applications
- High Conversion Efficiency
- Low R_{DS(ON)} Minimizes On-State Losses
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

Mechanical Data

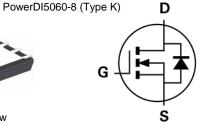
- Package: PowerDI[®]5060-8
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 3
- Weight: 0.097 grams (Approximate)



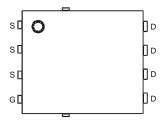




Bottom View



Internal Schematic



Top View Pin Configuration

Ordering Information (Note 4)

Part Number	Paakaga	Packing		
Fait Number	Package	Qty.	Carrier	
DMTH8003SPS-13	PowerDI5060-8 (Type K)	2,500	Tape & Reel	

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



☐ H = Manufacturer's Marking
TH8003SS = Product Type Marking Code
YYWW = Date Code Marking
YY = Last Two Digits of Year (ex: 21 = 2021)
WW = Week Code (01 to 53)

PowerDI is a registered trademark of Diodes Incorporated.



Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	VDSS	80	V	
Gate-Source Voltage		V_{GSS}	±20	V
Continuous Drain Current, V _G s = 10V (Note 6)	T _C = +25°C T _C = +100°C	lo	120	A
	IC = +100°C		85	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		IDМ	480	Α
Continuous Body Diode Forward Current (Note 6) $T_C = +25^{\circ}C$		Is	95	Α
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)	Ism	480	Α	
Avalanche Current, L = 3mH (Note 8)		las	15.8	Α
Avalanche Energy, L = 3mH (Note 8)		Eas	375.4	mJ
Avalanche Current, L = 0.1mH		I _{AS}	65	Α
Avalanche Energy, L = 0.1mH		Eas	211.4	mJ

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	PD	2.9	W
Thermal Resistance, Junction to Ambient (Note 5)	R _θ JA	51	°C/W
Total Power Dissipation (Note 6)	PD	125	W
Thermal Resistance, Junction to Case (Note 6)	Rejc	1.2	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +175	°C

Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

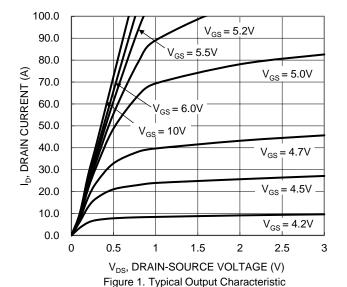
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BVDSS	80	1	_	V	$V_{GS} = 0V$, $I_D = 1mA$	
Zero Gate Voltage Drain Current	IDSS	_		1	μA	V _{DS} = 64V, V _{GS} = 0V	
Gate-Source Leakage	Igss		_	±100	nA	$V_{GS} = \pm 20V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	Vgs(TH)	2		4	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
Static Drain-Source On-Resistance			3.1	3.9	mΩ	$V_{GS} = 10V, I_{D} = 30A$	
Static Dialif-Source Off-Nesistance	Rds(on)	_	4.1	6	mΩ	$V_{GS} = 6V, I_D = 30A$	
Diode Forward Voltage	VsD		-	1.3	V	V _G S = 0V, I _S = 30A	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss		8,952	_		$V_{DS} = 40V$, $V_{GS} = 0V$, $f = 1MHz$	
Output Capacitance	Coss		533	_	pF		
Reverse Transfer Capacitance	Crss		26				
Gate Resistance	R_g		0.85	1	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge	Q_g		124.3	_			
Gate-Source Charge	Qgs	1	24.3		nC	V _{DS} = 40V, I _D = 30A, V _{GS} = 10V	
Gate-Drain Charge	Q_{gd}	1	35.7				
Turn-On Delay Time	t _{D(ON)}		12.6			V _{DD} = 40V, V _{GS} = 10V,	
Turn-On Rise Time	t _R	1	24.4		no		
Turn-Off Delay Time	tD(OFF)	_	47.9	_	ns	$I_D = 30A, R_g = 2.5\Omega$	
Turn-Off Fall Time	tF		20.9	_	<u></u>		
Reverse Recovery Time	t _{RR}	_	56.2	_	ns	I_ FOA di/dt 1004/vo	
Reverse Recovery Charge	Q_{RR}	1	118.7	_	nC	I _F = 50A, di/dt = 100A/μs	

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.

6. Thermal resistance from junction to soldering point (on the exposed drain pad).
7. Short duration pulse test used to minimize self-heating effect.

^{8.} Guaranteed by design. Not subject to product testing.





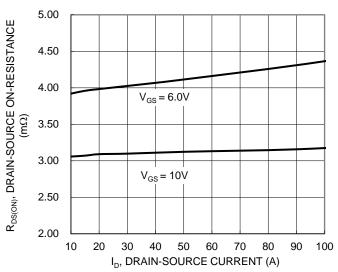


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

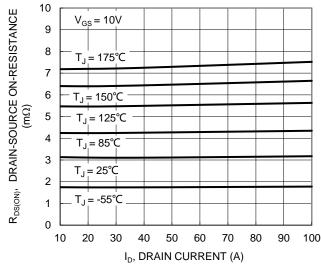


Figure 5. Typical On-Resistance vs. Drain Current and Temperature

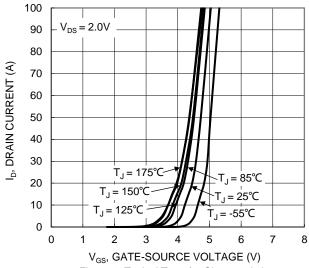


Figure 2. Typical Transfer Characteristic

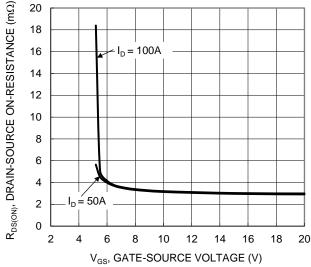


Figure 4. Typical Transfer Characteristic

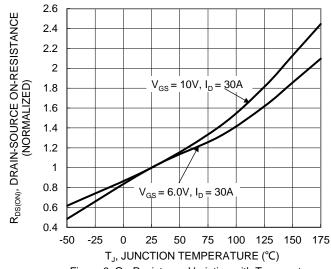


Figure 6. On-Resistance Variation with Temperature



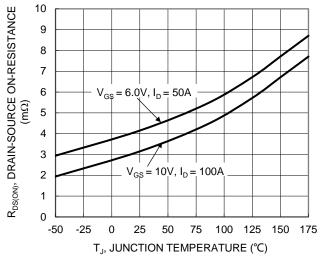
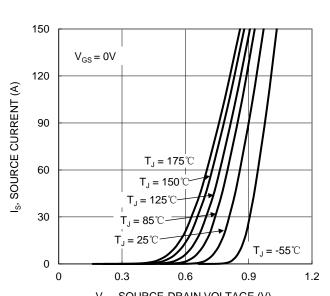


Figure 7. On-Resistance Variation with Temperature



V_{SD}, SOURCE-DRAIN VOLTAGE (V) Figure 9. Diode Forward Voltage vs. Current

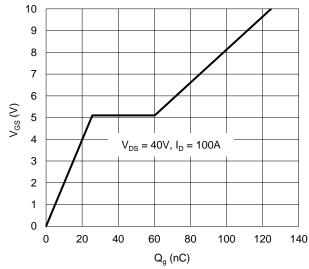


Figure 11. Gate Charge

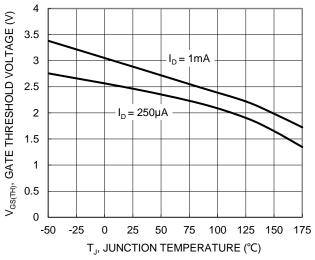


Figure 8. Gate Threshold Variation vs. Junction Temperature

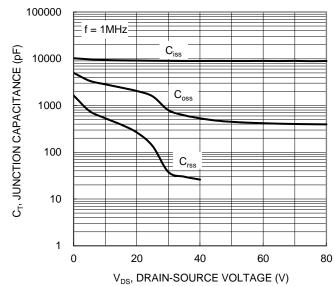


Figure 10. Typical Junction Capacitance

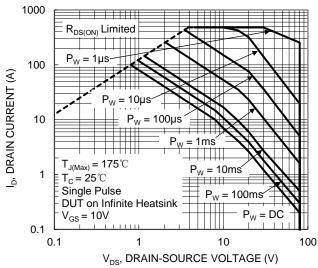


Figure 12. SOA, Safe Operation Area



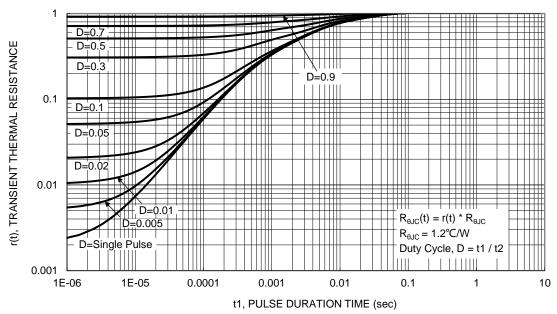


Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

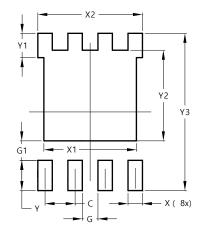
PowerDI5060-8 (Type K) D1 O1.000 Depth 0.07±0.030 DETAIL A DETAIL A DETAIL A

	PowerDI5060-8 (Type K)				
Dim	Min	Max	Тур		
Α	0.90	1.10	1.00		
A1	0	0.05	0.02		
b	0.33	0.51	0.41		
b1	0.300	0.366	0.333		
b2	0.20	0.35	0.25		
С	0.23	0.33	0.277		
D	5	.15 BS0)		
D1	4.85	4.95	4.90		
D2	-	-	3.98		
Е	6.15 BSC				
E1	5.75	5.85	5.80		
E2	3.56	3.725	3.66		
е	1	.27BSC)		
k	-	-	1.27		
L	0.51	0.71	0.61		
La	0.51	0.675	0.61		
L1	0.05	0.20	0.175		
L4	-	-	0.125		
М	3.50	3.71	3.605		
Х	-	-	1.400		
у	-	-	1.900		
θ	10°	12°	11°		
θ1	6°	8°	7°		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8 (Type K)



Dimensions	Value (in mm)		
C	1.270		
G	0.660		
G1	0.820		
X	0.610		
X1	3.910		
X2	4.420		
Y	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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